

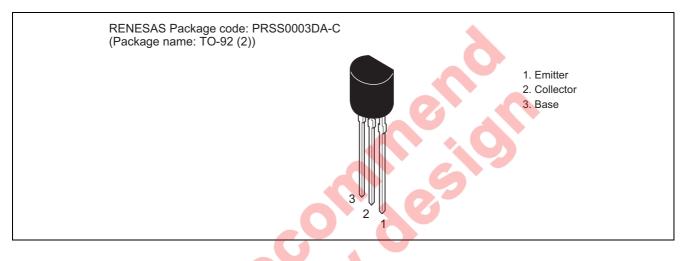
2SC535 Silicon NPN Epitaxial Planar

REJ03G0683-0200 (Previous ADE-208-1047) Rev.2.00 Aug.10.2005

Application

VHF amplifier, mixer, local oscillator

Outline



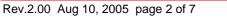
Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Collector to base voltage	V _{CBO}	30	V
Collector to emitter voltage	V _{CEO}	20	V
Emitter to base voltage	V _{EBO}	4	V
Collector current	Ι _C	20	mA
Collector power dissipation	Pc	100	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	–55 to +150	°C



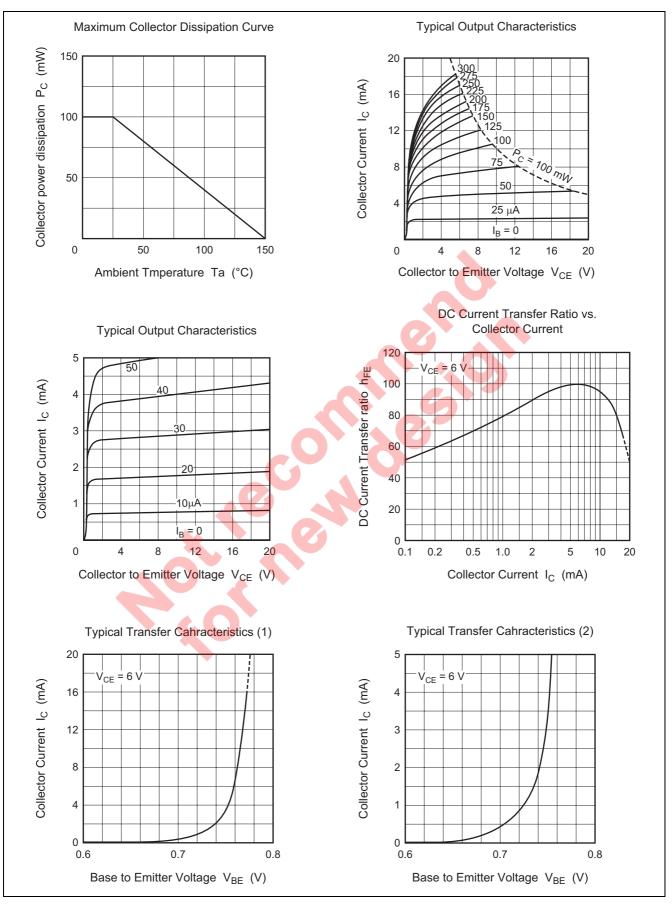
Electrical Characteristics

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	V _{(BR)CBO}	30	- JP		V	$I_{\rm C} = 10 \mu \text{A}, I_{\rm E} = 0$
Collector to emitter breakdown voltage	V _{(BR)CEO}	20	_		V	$I_c = 1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	V _{(BR)EBO}	4			V	$I_E = 10 \ \mu A, I_C = 0$
Collector cutoff current	I _{CBO}			0.5	μA	$V_{CB} = 10 \text{ V}, \text{ I}_{E} = 0$
DC current transfer ratio	h _{FE} * ¹	60	_	200	μ	$V_{CE} = 6 V, I_C = 1 mA$
Base to emitter voltage	V _{BE}		0.72		V	$V_{CE} = 6 V, I_C = 1 mA$
Collector to emitter saturation voltage	V _{CE(sat)}	_	0.12	_	V	$I_{\rm C} = 20 \text{ mA}, I_{\rm B} = 4 \text{ mA}$
Gain bandwidth product	f _T	450	940		MHz	$V_{CE} = 6 V, I_C = 5 mA$
Collector output capacitance	Cob		0.9	1.2	pF	$V_{CB} = 10 \text{ V}, \text{ I}_{E} = 0, \text{ f} = 1 \text{ MHz}$
Power gain	PG	17	20	1.2	dB	$V_{CE} = 6 V, I_C = 1 mA,$
Fower gain	FG	17	20		uВ	f = 100 MHz
Noise figure	NF		3.5	5.5	dB	$V_{CE} = 6 V, I_C = 1 mA,$
Noise ligure	1 11		0.0	0.0	uD	$f = 100 \text{ MHz}, R_g = 50 \Omega$
Input admittance (typ)	yie		l 1.3 + j5.3		mS	$V_{CE} = 6 \text{ V}, \text{ I}_{C} = 1 \text{ mA},$
input durintarioe (typ)	yic	1.5 + j5.5				f = 100 MHz
Reverse transfer admittance (typ)	yre	-0.078 - j0.41		mS		
Forward transfer admittance (typ)	yfe		. <u></u>		mS	
Output admittance (typ)	yoe			mS		
B C 60 to 120 100 to 200	FE as follows			0		

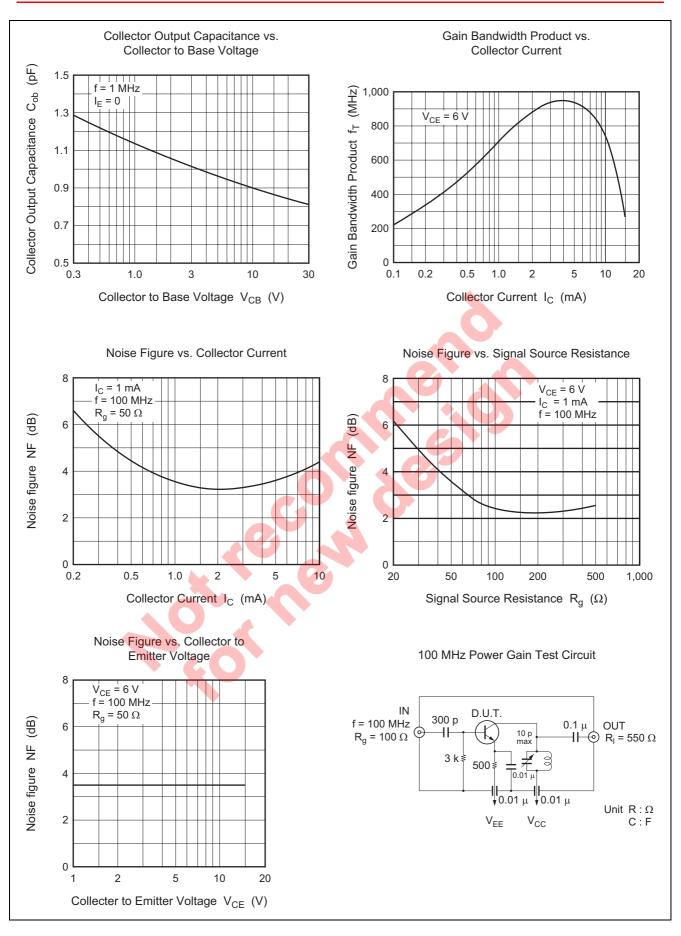




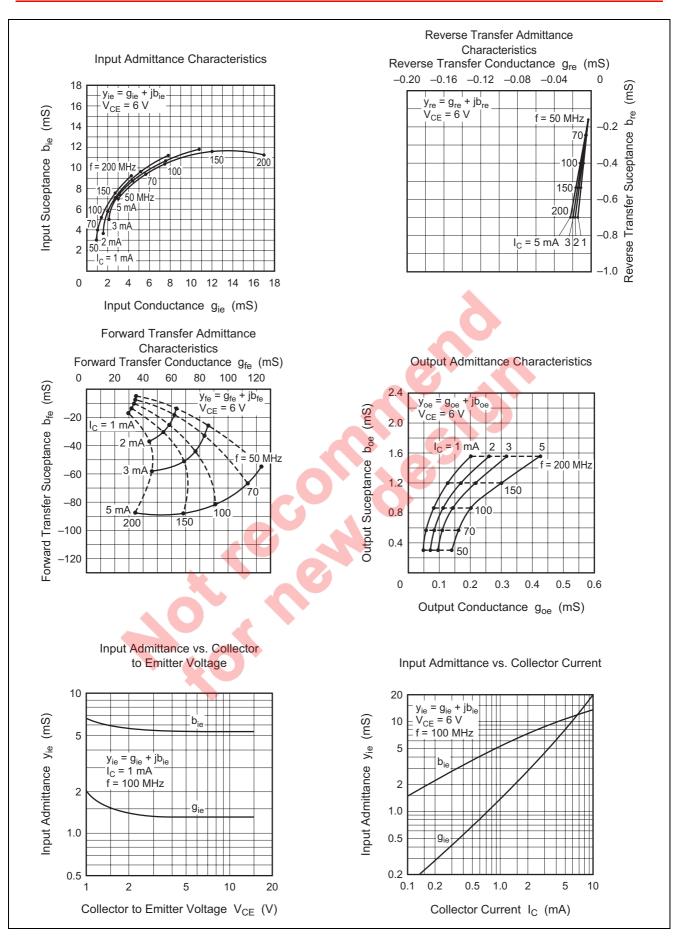
Main Characteristics



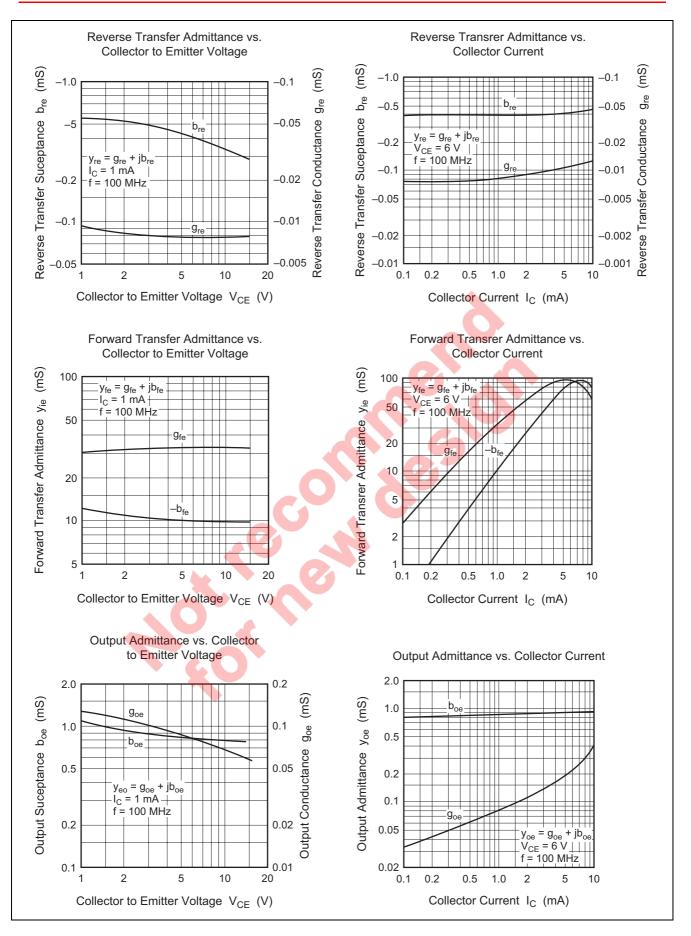






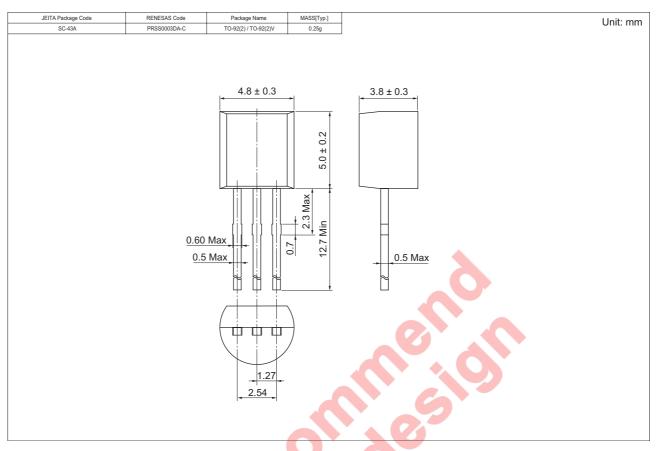








Package Dimensions



Ordering Information

Part Name		Quantity		Shipping Container
2SC535BTZ	2500		Hold	Box, Radial Taping
2SC535CTZ				

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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